

Effects of Nanoparticle Inclusion on Properties of Si Films Deposited by Plasma CVD

プラズマCVDで成膜したSi薄膜へのナノ粒子含有の効果

Masaharu Shiratani¹, Yeonwon Kim¹, Takeaki Matsunaga¹, Hyunwoong Seo²,
Kunihiro Kamataki³, Giichiro Uchida¹, Naho Itagaki¹, Kazunori Koga¹,
白谷正治¹, 金 淵元¹, 松永剛明¹, 徐 鉉雄²,
鎌滝晋礼³, 内田儀一郎¹, 板垣奈穂¹, 古閑一憲¹,

¹Graduate School of Information Science and Electrical Engineering, ²Center of Plasma Nano-interface Engineering,
³Center for Research and Advancement in Higher Education
Kyushu University, Fukuoka 819-0395, Japan

¹九州大学大学院システム情報科学府, ²九州大学プラズマ界面工学センター,
³九州大学高等教育開発推進センター 〒819-0373 福岡市西区元岡744ウエスト2号館4F423号室

We have investigated effects of nanoparticle inclusion on properties of a-Si:H films and mc-Si:H films using the multi-hollow discharge plasma CVD method. Minor deposition species (nanoparticles in this study) modify considerably properties of a-Si:H films and mc-Si:H films.

1. Introduction

A-Si:H and mc-Si:H films are dominant materials for thin film solar cells. These films are widely deposited by plasma CVD. Nanoparticles are often formed in such CVD plasmas and may modify properties of films [1-7]. Here we report effects of nanoparticle inclusion on properties of a-Si:H films and mc-Si:H films.

2. Experimental

Multi-hollow discharge plasma CVD reactor consists of one powered electrode and a pair of grounded electrodes to generate plasma as shown in Fig. 1[3]. 60MHz voltage was applied to the electrode to sustain the discharges in the holes in the electrodes.

Pure SiH₄ or H₂+SiH₄ was supplied to the reactor. The total pressure and gas flow rate were 0.5-2 Torr and 15-150 sccm, respectively. The substrate holder was set vertically or perpendicularly to the gas flow. The substrate temperature (T_S) was 250°C. Information on chemical bonds in films was obtained by FTIR. Crystallinity (X_C) was determined with a Raman spectroscope (Jasco, NRS-3100). Deposition rate (R_d) was obtained as film thickness divided by deposition time.

3. Experimental results and discussion

3-1. a-Si:H films

First, we study effects of amorphous Si nanoparticle inclusion on properties of a-Si:H films. Figure 2 shows FTIR spectrum of nanoparticles formed in pure discharge plasmas. While SiH and

SiH₂ bonds exist in nanoparticles, SiH₂ bonds have larger absorption.

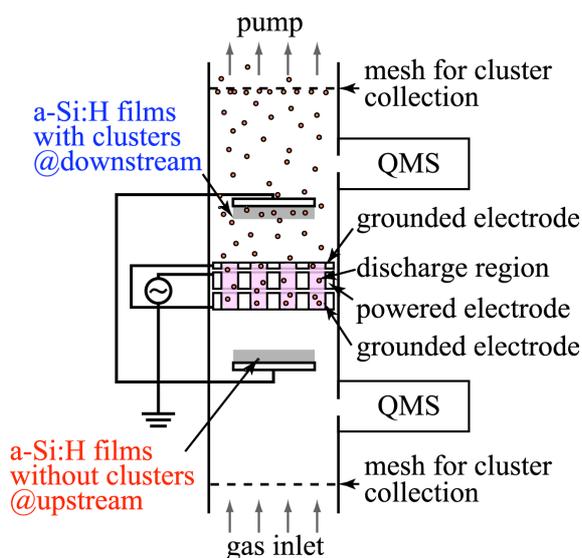


Fig. 1. Schematic diagram of a multi-hollow discharge CVD reactor.

Figure 3 shows FTIR spectra for a-Si:H films deposited in the downstream region and in the upstream region. The films in the downstream region have predominant SiH absorption and small SiH₂ one, while the films in the upstream region only have SiH absorption. The films in the downstream region contain nanoparticles of 1% in volume fraction, whereas the films in the upstream region do not contain them (<0.01% in volume fraction). These results suggest that SiH₂ bonds are originated from nanoparticle inclusion. Such nanoparticle inclusion brings about light induced

degradation of a-Si:H films, because SiH₂ bonds are weaker than SiH ones. This consideration is consistent with the fact that the films in the upstream show little light induced degradation, whereas the films in the downstream region show significant light induced degradation.

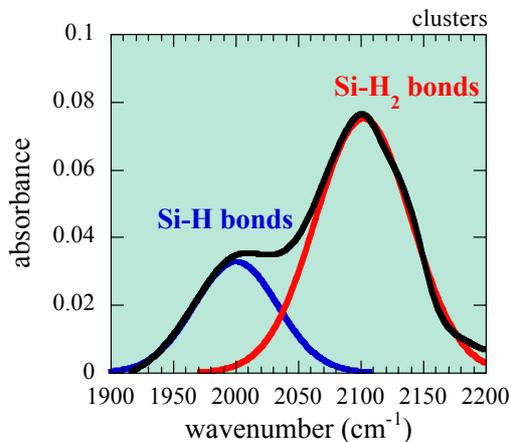


Fig. 2. FTIR spectrum of nanoparticles formed in pure discharge plasmas.

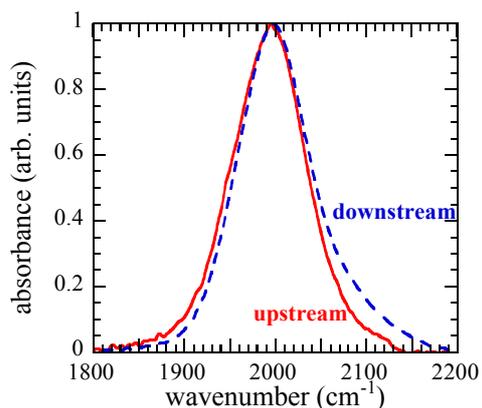


Fig. 3. FTIR spectra for a-Si:H films deposited in the downstream region and in the upstream region.

3-1. mc-Si:H films

Next, we study effects of crystalline Si nanoparticle inclusion on properties of mc-Si:H films. Nanoparticle inclusion has little effects on deposition rate and crystallinity. The volume fraction of (220) crystalline orientation crystals of the films without nano-particles is higher than that with nano-particles. A cross sectional SEM of mc-Si:H films deposited in the upstream region is shown in Fig. 4, while that in the downstream region is shown in Fig. 5. The film without nanoparticles has columnar grain growth, whereas the film with nanoparticles has inverted conical growth. Therefore, nanoparticle inclusion of 1% volume fraction considerably modifies the crystal grain growth in mc-Si:H films.

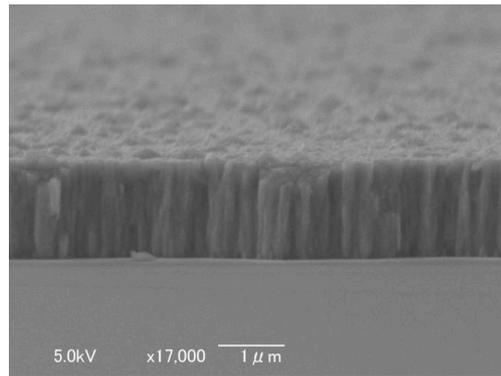


Fig. 4. A cross sectional SEM of mc-Si:H films deposited in the upstream region.

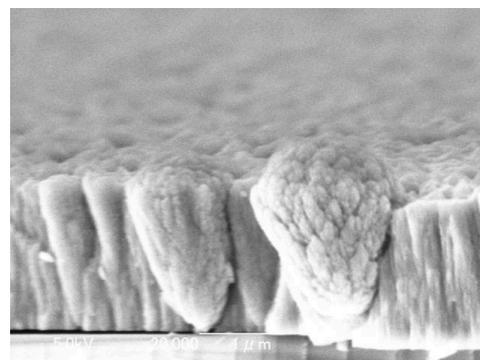


Fig. 5. A cross sectional SEM of mc-Si:H films deposited in the downstream region.

4. Conclusions

We have investigated effects of nanoparticle inclusion on properties of a-Si:H films and mc-Si:H films using the multi-hollow discharge plasma CVD method. Minor deposition species (nanoparticles in this study) modify considerably properties of a-Si:H films and mc-Si:H films.

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